## **Power MOSFET** 60 V, 65 m $\Omega$ , 12 A, Dual N–Ch Logic Level

#### Features

- Small Footprint (5x6 mm) for Compact Designs
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- 175°C Operating Temperature
- NVMFD5489NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- This is a Pb–Free Device

#### MAXIMUM RATINGS (T<sub>.1</sub> = 25°C unless otherwise noted)



Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit
Junction-to-Mounting Board (top) – Steady State (Notes 2, 3)	$R_{\Psi J-mb}$	6.4	
Junction-to-Ambient - Steady State (Note 3)		50	°C/W
Junction-to-Ambient – Steady State (min footprint)	$R_{ hetaJA}$	161	

The entire application environment impacts the thermal resistance values shown, 1. they are not constants and are only valid for the particular conditions noted.

- 2. Psi ( $\Psi$ ) is used as required per JESD51-12 for packages in which substantially less than 100% of the heat flows to single case surface. 3
- Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.
- Continuous DC current rating. Maximum current for pulses as long as 1 4. second are higher but are dependent on pulse duration and duty cycle.



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V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> MAX	I <sub>D</sub> MAX
60 V	65 mΩ @ 10 V	12 Δ
	79 mΩ @ 4.5 V	12 7

**Dual N-Channel** D1 D2 Q G2



#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NVMFD5489NLT1G	DFN8 (Pb–Free)	1500/ Tape & Reel
NVMFD5489NLT3G	DFN8 (Pb-Free)	5000/ Tape & Reel
NVMFD5489NLWFT1G	DFN8 (Pb–Free)	1500/ Tape & Reel
NVMFD5489NLWFT3G	DFN8 (Pb-Free)	5000/ Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Мах	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>	Reference to 25°C I <sub>D</sub> = 250 μA			67		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$			1.0	μΑ
		V <sub>DS</sub> = 60 V	$T_J = 125^{\circ}C$			10	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} =$	= ±20 V			±100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D =$	250 μΑ	1.5		2.5	V
Negative Threshold Temperature Co- efficient	V <sub>GS(TH)</sub> /T <sub>J</sub>	Reference to 25°C I <sub>D</sub> = 250 μA			4.86		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> =	= 15 A		52	65	mΩ
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> :	4.5 V, I <sub>D</sub> = 7.5 A		66	79	
CHARGES AND CAPACITANCES	•	•					
Input Capacitance	C <sub>iss</sub>				330		pF
Output Capacitance	C <sub>oss</sub>	$V_{GS}$ = 0 V, f = 1.0 MHz, $V_{DS}$ = 25 V			80		
Reverse Transfer Capacitance	C <sub>rss</sub>				39		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 48 V, I <sub>D</sub> = 6 A			12.4		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>				0.31		
Gate-to-Source Charge	Q <sub>GS</sub>				1.3		
Gate-to-Drain Charge	Q <sub>GD</sub>				4.74		
SWITCHING CHARACTERISTICS (No	ote 6)	-					
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 48 V, $I_D$ = 6 A, $R_G$ = 2.5 $\Omega$			7		ns
Rise Time	t <sub>r</sub>				11		
Turn–Off Delay Time	t <sub>d(off)</sub>				31		1
Fall Time	t <sub>f</sub>				21		
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$		0.83	1.2	V
		I <sub>S</sub> = 10 A	T <sub>J</sub> = 125°C		0.71		
Reverse Recovery Time	t <sub>RR</sub>	$V_{GS} = 0 V, d_{IS}/d_t = 100 A/\mu s,$ $I_S = 10 A$			24.2		ns
Charge Time	t <sub>a</sub>				20.2		
Discharge Time	t <sub>b</sub>				4.0		
Reverse Recovery Charge	Q <sub>RR</sub>				26.5		nC
PACKAGE PARASITIC VALUES							
Source Inductance	L <sub>S</sub>	T <sub>A</sub> = 25°C			0.93		nH
Drain Inductance	L <sub>D</sub>				0.005		
Gate Inductance	L <sub>G</sub>				1.84		

Gate Resistance

 $\begin{array}{ll} \text{5. Pulse Test: pulse width = 300 } \mu\text{s, duty cycle} \leq 2\%. \\ \text{6. Switching characteristics are independent of operating junction temperatures.} \end{array}$ 

 $\mathsf{R}_\mathsf{G}$ 

12

Ω

#### **TYPICAL CHARACTERISTICS**



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#### **TYPICAL CHARACTERISTICS**



Figure 12. Thermal Response

#### PACKAGE DIMENSIONS



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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